

OptiMOS™-T Power-Transistor





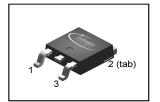
Product Summary

V _{DS}	120	V
$R_{\mathrm{DS(on),max}}$	11.1	mΩ
I _D	70	Α

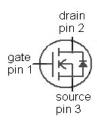
Features

- OptiMOS™ power MOSFET for automotive applications
- N-channel Enhancement mode
- Automotive AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

PG-TO252-3-11



Туре	Package	Marking
IPD70N12S3-11	PG-TO252-3-11	QN1211



Maximum ratings, at T_i =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I _D	T _C =25°C, V _{GS} =10V	70	Α
		$T_{\rm C}$ =100°C, $V_{\rm GS}$ =10 $V^{1)}$	48	
Pulsed drain current ¹⁾	I _{D,pulse}	T _C =25°C	280	
Avalanche energy, single pulse ¹⁾	E _{AS}	I _D =35A	410	mJ
Avalanche current, single pulse	IAS	-	70	А
Gate source voltage	V_{GS}	-	±20	V
Power dissipation	P _{tot}	T _C =25 °C	125	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 +175	°C



Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal characteristics ¹⁾						
Thermal resistance, junction - case	R _{thJC}	-	-	-	1.2	K/W
SMD version, device on PCB	R _{thJA}	minimal footprint	-	-	62	
		6 cm ² cooling area ²⁾	-	-	40]

Electrical characteristics, at T_j =25 °C, unless otherwise specified

Static characteristics

Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0V, I _D = 1mA	120	-	-	V
Gate threshold voltage	V _{GS(th)}	$V_{\rm DS}=V_{\rm GS}, I_{\rm D}=83\mu{\rm A}$	2.0	3.0	4.0	
Zero gate voltage drain current	I _{DSS}	V _{DS} =120V, V _{GS} =0V, T _j =25°C	-	0.01	0.1	μA
		$V_{\rm DS}$ =120V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =125°C ¹⁾	-	1	10	
Gate-source leakage current	I _{GSS}	V _{GS} =20V, V _{DS} =0V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10V, I _D =70A	-	9.2	11.1	mΩ



Parameter	Symbol Conditions		Values			Unit	
			min.	typ.	max.	1	
Dynamic characteristics ¹⁾							
Input capacitance	C iss		-	3350	4355	pF	
Output capacitance	Coss	V _{GS} =0V, V _{DS} =25V, f=1MHz	-	940	1222		
Reverse transfer capacitance	C _{rss}		-	105	158		
Turn-on delay time	t _{d(on)}		-	17	-	ns	
Rise time	t _r	V _{DD} =20V, V _{GS} =10V,	-	8	-		
Turn-off delay time	t _{d(off)}	$I_{\rm D}$ =70A, $R_{\rm G}$ =3.5 Ω	-	25	-		
Fall time	t _f		-	8	-		
Gate Charge Characteristics ¹⁾							
Gate to source charge	Q _{gs}		-	18	23	nC	
Gate to drain charge	Q _{gd}	V_{DD} =96V, I_{D} =70A,	-	16	24		
Gate charge total	Q _g	$V_{\rm GS}$ =0 to 10V	-	51	65		
Gate plateau voltage	V _{plateau}		-	5.5	-	V	
Reverse Diode							
Diode continous forward current ¹⁾	Is	- T _C =25°C	-	-	70	А	
Diode pulse current ¹⁾	I _{S,pulse}	7 _C -23 C	-	-	280		
Diode forward voltage	V _{SD}	V _{GS} =0V, I _F =70A, T _j =25°C	0.6	1	1.2	V	
Reverse recovery time ¹⁾	t _{rr}	V_R =60V, I_F =50A, di_F/dt =100A/ μ s	-	100	-	ns	
Reverse recovery charge ¹⁾	Q _{rr}		-	265	-	nC	

¹⁾ Defined by design. Not subject to production test.

 $^{^{2)}}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.



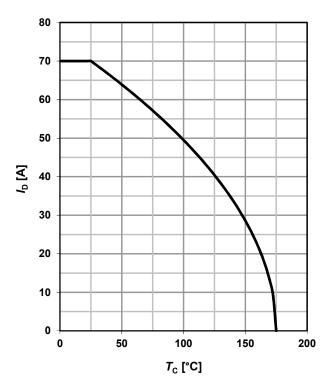
1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} = 10 \text{ V}$$

140 120 100 80 80 40 20 0 0 50 100 150 200 T_C [°C]

2 Drain current

$$I_{\rm D} = f(T_{\rm C}); V_{\rm GS} = 10 \text{ V}$$



3 Safe operating area

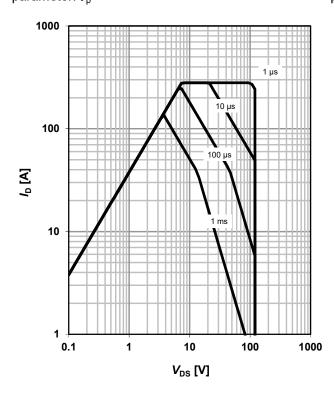
$$I_D = f(V_{DS}); T_C = 25 \,^{\circ}C; D = 0$$

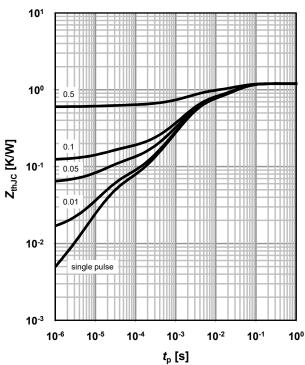
parameter: t_p

4 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$

parameter: $D = t_p/T$



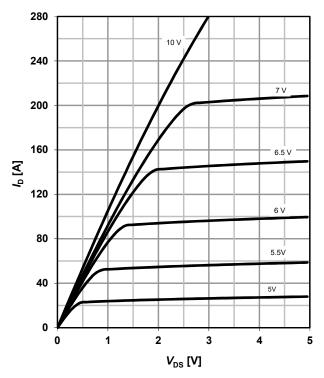




5 Typ. output characteristics

 $I_D = f(V_{DS}); T_i = 25 °C$

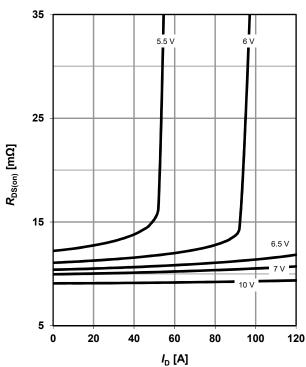
parameter: $V_{\rm GS}$



6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25 °C$

parameter: V_{GS}



7 Typ. transfer characteristics

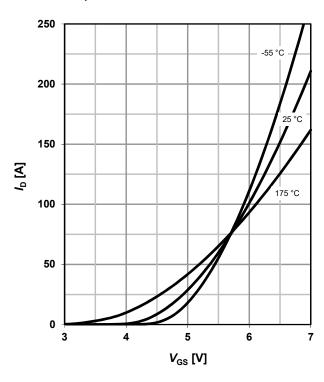
 $I_D = f(V_{GS}); V_{DS} = 6V$

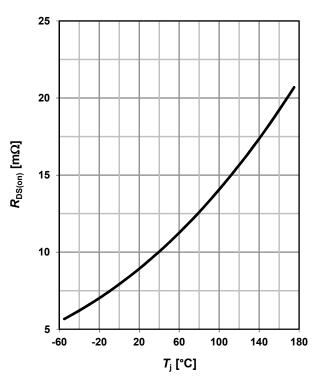
parameter: T_i

8 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = 70 A; V_{GS} = 10 V$

 $\alpha = 0.4$







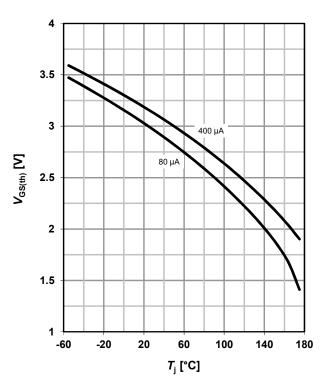
9 Typ. gate threshold voltage

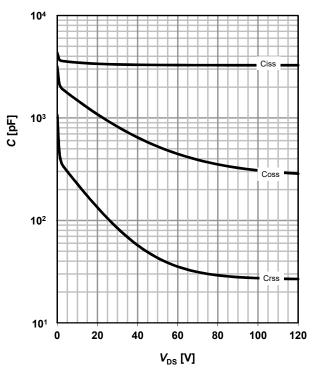
 $V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter: I_D

10 Typ. capacitances

 $C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$

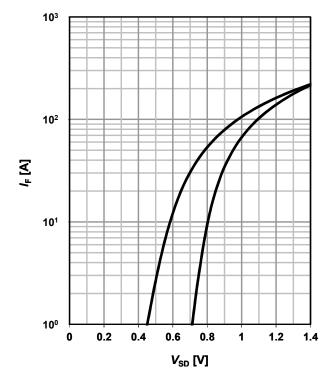




11 Typical forward diode characteristics

 $I_{\rm F} = f(V_{\rm SD})$

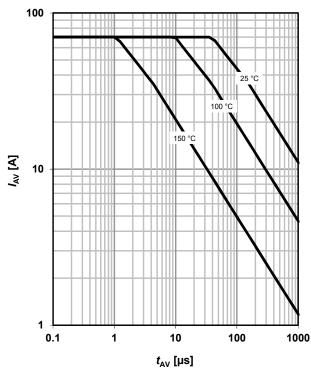
parameter: $T_{\rm j}$



12 Typ. avalanche characteristics

 $I_{AS} = f(t_{AV})$

parameter: $T_{j(start)}$





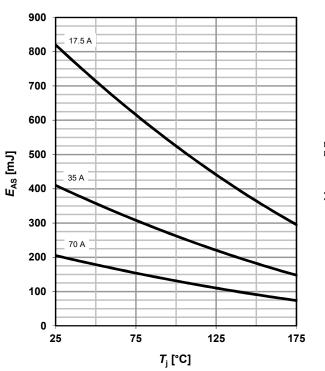
13 Typical avalanche energy

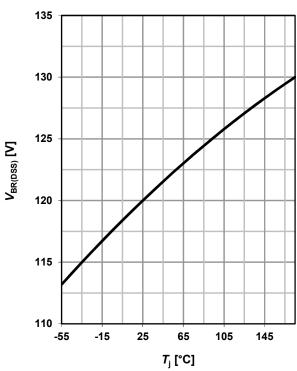
 $E_{AS} = f(T_i)$

parameter: I_D

14 Typ. drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$

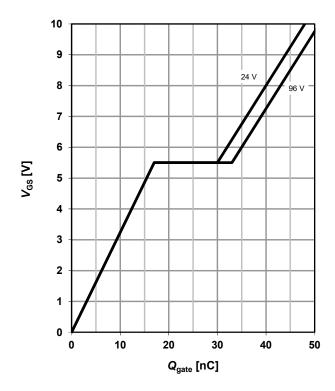




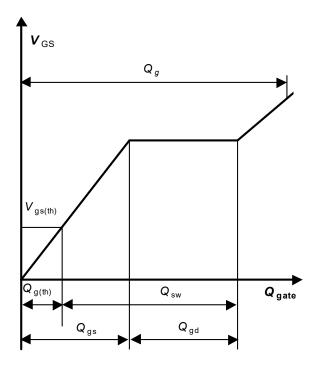
15 Typ. gate charge

 $V_{GS} = f(Q_{gate}); I_D = 70 A pulsed$

parameter: $V_{\rm DD}$



16 Gate charge waveforms





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Revision History

Version	Date	Changes
Revision 1.0	2016-06-20	Final Data Sheet
Revision 1.1	2023-06-15	Diagram 8 Typ. drain-source on- state resistance: used α value clarified
Revision 1.1	2023-06-15	Corrected diagram 10 typical capacitances